

## POWER DIODE MODULE

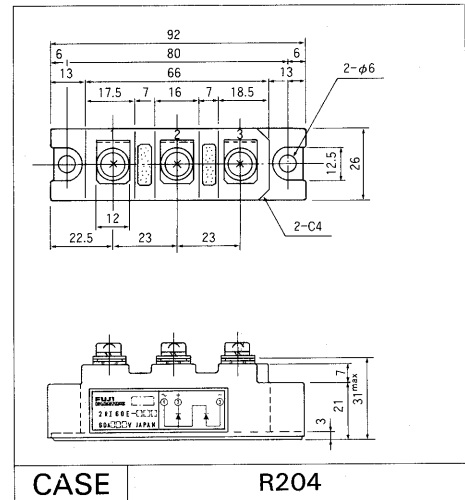
### Features

- All the terminals and the mounting plate are electrically isolated. These modules can be installed in the same cooling fin as other modules, thus saving installation space – a cost-effective feature.
- The diode chips are coated with a glass of zinc oxide, making them highly resistant to temperature and humidity variation.
- Two diodes chips are connected in series internally, so allowing the rectifying circuit to be simplified.

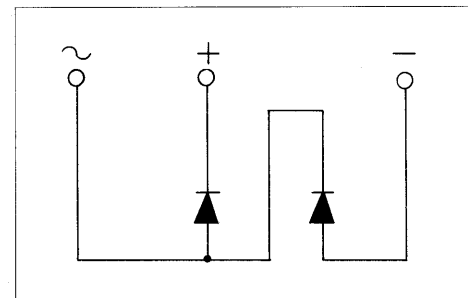
### Applications

- Inverters for AC motors
- Power supply units for DC motors
- DC power supply units for battery chargers
- General purpose DC power supply units

## Outline Drawings



## Inner Circuit Schematic



## Maximum Ratings and Characteristics

### Absolute Maximum Ratings

Items	Symbols	Conditions	2RI60E		Units
			-060	-080	
Repetitive peak reverse voltage	$V_{RRM}$		600	800	V
Non-repetitive peak reverse voltage	$V_{RSM}$		660	880	V
Average forward current	$I_{F(AV)}$	50/60 Hz Sinewave, $T_C = 103^\circ\text{C}$	60×2		A
Surge current	$I_{FSM}$	Rated load conditions	1200		A
$I^2_t$	$I^2_t$	Rated load conditions	6000		$\text{A}^2\text{s}$
Junction temperature	$T_j$		-40~+150		$^\circ\text{C}$
Storage temperature	$T_{stg}$		-40~+150		$^\circ\text{C}$
Tightening torque		Mounting screw: M5	25±5		kg·cm
Vibration resistance			5		G
Dielectric strength		Between terminals and base	2000 VAC 1min		
Net. Weight			180		g

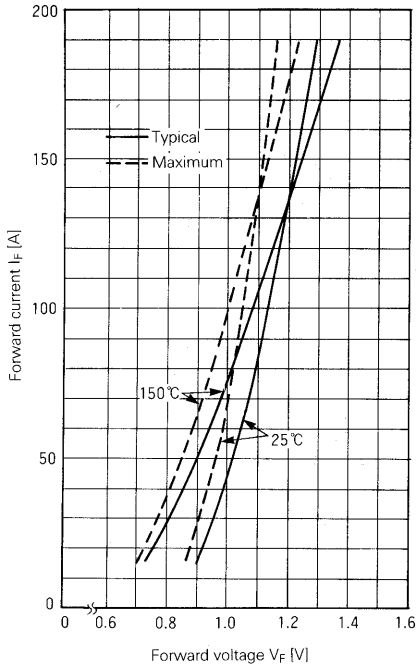
### Electrical Characteristics

Items	Symbols	Conditions	Min	Typ	Max	Units
Forward voltage	$V_{FM}$	$T_j = 25^\circ\text{C}$ , $I_{FM} = 190\text{ A}$			1.30	V
Reverse current	$I_{RRM}$	$T_j = 150^\circ\text{C}$ , $V_R = V_{RRM}$			20	mA

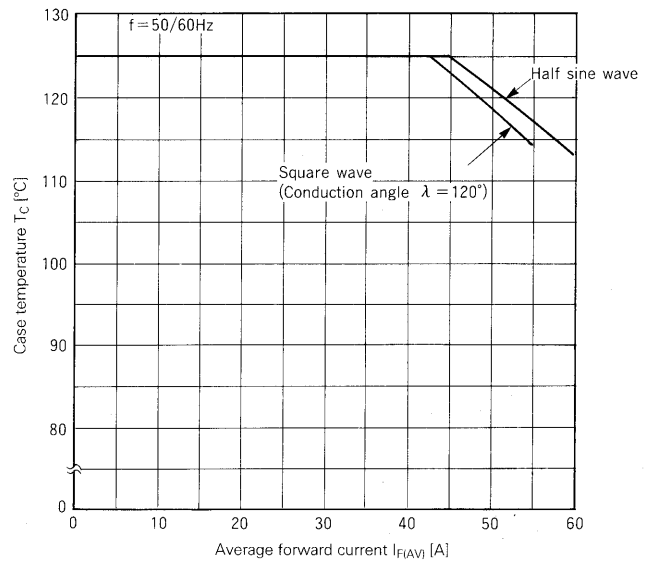
### Thermal Characteristics

Items	Symbols	Conditions	Min	Typ	Max	Units
Thermal resistance (Junction to case)	$R_{th(j-c)}$	50/60 Hz Sinewave, Thermal resistance for total loss			0.25	$^\circ\text{C}/\text{W}$
Thermal resistance	$R_{th(c-f)}$	With thermal compound			0.10	$^\circ\text{C}/\text{W}$

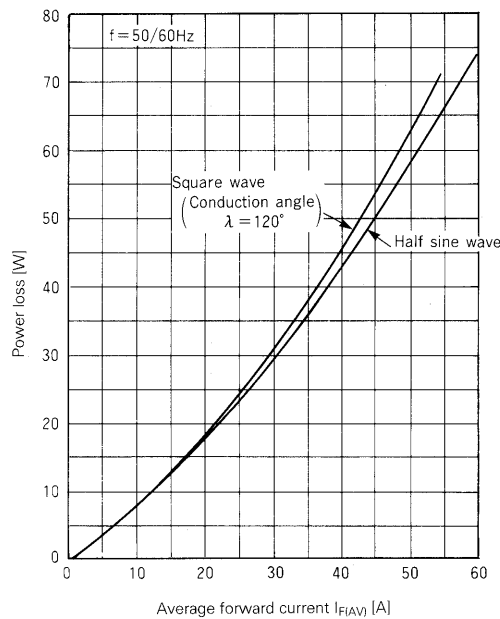
■ Characteristic curves



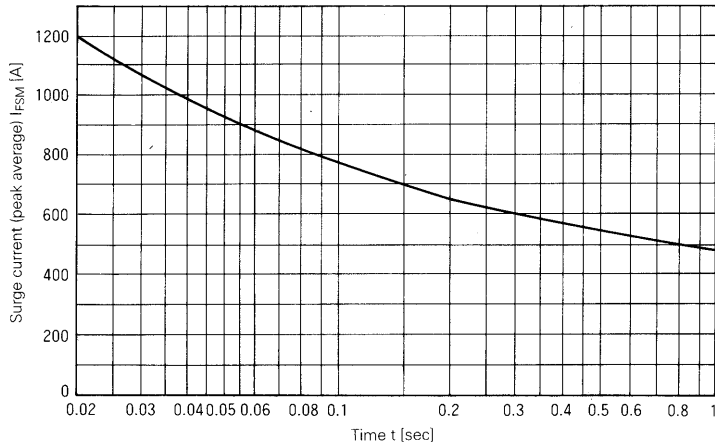
Forward Characteristics



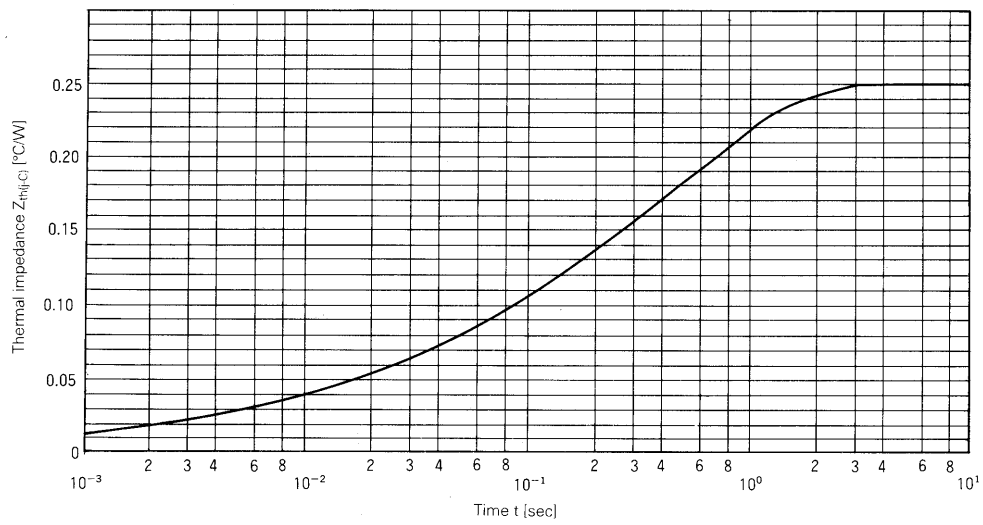
Case Temperature-Forward Average Current



Power Loss-Average Forward Current



Surge Current



Transient Thermal Impedance

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